

## **SSC8043GS6A**

#### **P-Channel Enhancement Mode MOSFET**

#### Features

V <sub>DS</sub>	V <sub>GS</sub>	R <sub>DS(ON)</sub> Typ.	l <sub>D</sub>
-40V	+20V	28mΩ@-10V	-7A
-40 V	<u> </u>	35mΩ@-4V5	-76

#### > Description

The SSC8043GS6A is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in load switch, DCDC conversion and battery isolation.

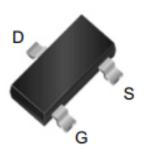
#### Applications

- Load Switch
- DCDC Conversion
- Battery Isolation

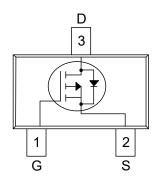
## Ordering Information

Device	Package	Shipping
SSC8043GS6A	SOT-23-3L	3000/Reel

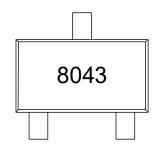
## Pin configuration



**SOT-23-3L** 



**Pin Configuration (Top View)** 



**Marking** 



### ➤ Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage	-40	V
V <sub>GSS</sub>	Gate-to-Source Voltage	±20	V
I <sub>D</sub>	Continuous Drain Current <sup>a</sup>	-7	Α
I <sub>DM</sub>	Pulsed Drain Current <sup>b</sup>	-28	Α
P <sub>D</sub>	Power Dissipation <sup>a</sup>	2.2	W
TJ	Operation junction temperature	Operation junction temperature -55~150	
T <sub>STG</sub>	Storage temperature range -55~150		$^{\circ}$

#### ➤ Thermal Resistance Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance <sup>a</sup>	56	°C/W

#### Note:

- a. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.



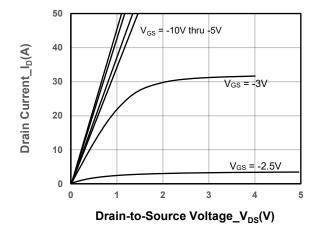


# $\succ$ Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

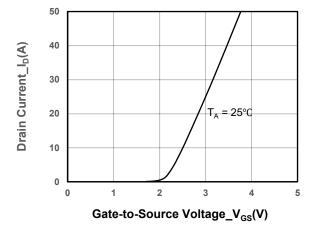
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-40			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250uA$	-1	-1.5	-2.5	V
Desir Course On Besistense	D	V <sub>GS</sub> = -10V, I <sub>D</sub> = -5A		28	45	0
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3A		35	55	mΩ
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = -40V, V <sub>GS</sub> = 0V			-1	μA
Gate-Source Leak Current	Igss	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
Transconductance	G <sub>FS</sub>	V <sub>DS</sub> = -10V, I <sub>D</sub> = -2A		10		S
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -2A		-0.8	-1.4	V
Input Capacitance	Ciss	V = 20V/V = 0V/		1280		
Output Capacitance	Coss	$V_{DS} = -20V$ , $V_{GS} = 0V$ , $f = 1MHz$		126		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>	T = TIVIHZ		115		
Turn-on Delay Time	T <sub>D(ON)</sub>			9.5		
Rise Time	Tr	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -20V,		4.5		
Turn-off Delay Time	T <sub>D(OFF)</sub>	$R_L = 3\Omega$ , $R_G = 1\Omega$		42		ns
Fall Time	T <sub>f</sub>			49		
Total Gate Charge	Q <sub>G</sub>	101/11/ 001/		17		
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -20V,		3.1		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = -2A		4.4		



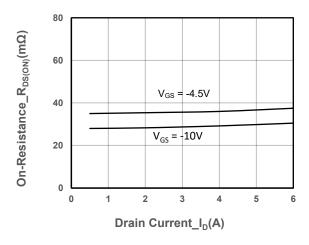
### ➤ Typical Performance Characteristics (T<sub>A</sub>=25°C unless otherwise noted)



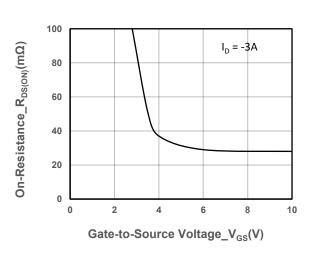
**Output Characteristics** 



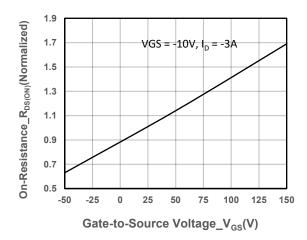
**Transfer Characteristics** 



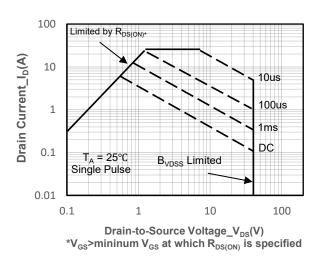
On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Gate-to-Source Voltage



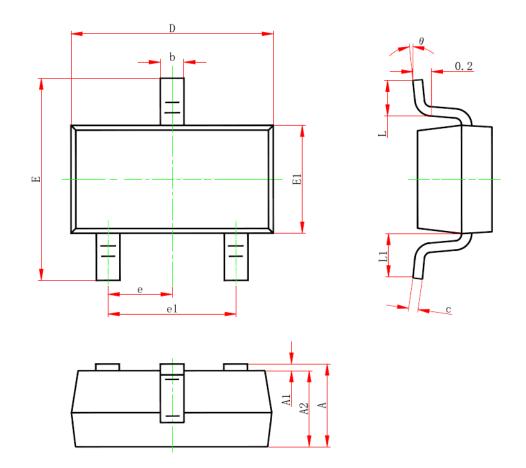
On-Resistance vs. Junction Temperature



Safe Operating Area vs. Junction-to-Ambient



## Package Information



Package: SOT-23-3L

C. mb a l	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
Α	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
С	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
Е	2.650	2.950	0.104	0.116
е	0.950	(BSC)	0.037	(BSC)
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
L1	0.600REF.		0.024REF.	
θ	0°	8°	0°	8°



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